

BIPOLAR ANALOG INTEGRATED CIRCUIT

μ PC4558

HIGH PERFORMANCE DUAL OPERATIONAL AMPLIFIER

DESCRIPTION

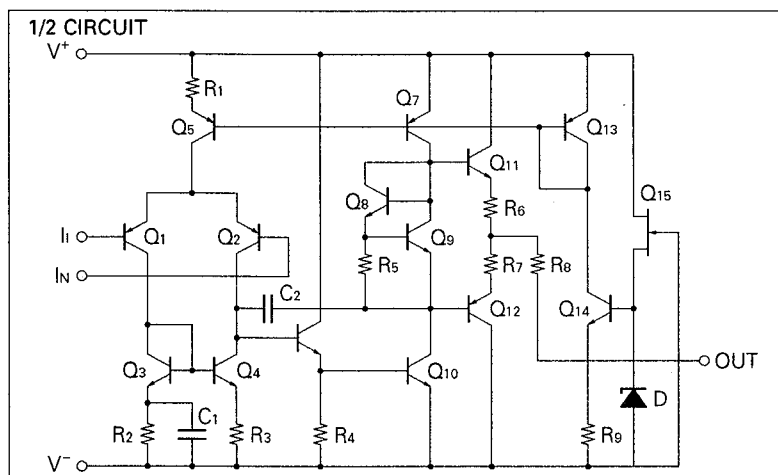
The μ PC4558 is a dual type operational amplifier having internal phase compensating circuits, its electrical characteristics features higher speed, broader bandwidth, and lower noise compared with such conventional general purpose operational amplifier as μ PC741.

Therefore, application to active filters, audio amplifiers, VCO, etc. can be realized with simple circuit composition.

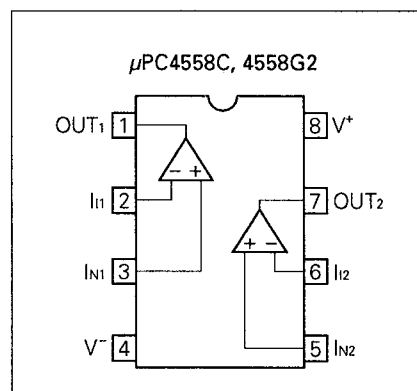
FEATURES

- Internal frequency compensation
- Low noise
- Output short circuit protection

EQUIVALENT CIRCUIT



CONNECTION DIAGRAM (Top View)



ORDERING INFORMATION

| PART NUMBER | PACKAGE | QUALITY GRADE |
|----------------|-----------------------------|---------------|
| μ PC4558C | 8 PIN PLASTIC DIP (300 mil) | Standard |
| μ PC4558G2 | 8 PIN PLASTIC SOP (225 mil) | Standard |

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specifications of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (T_a = 25 °C)

| PARAMETER | | SYMBOL | μPC4558 | UNIT |
|--|---------------------|---------------------------------|--|------|
| Voltage between V ⁺ and V ⁻ (Note 1) | | V ⁺ - V ⁻ | -0.3 to +36 | V |
| Differential Input Voltage | | V _{ID} | ±30 | V |
| Input Voltage (Note 2) | | V _I | V ⁻ -0.3 to V ⁺ +0.3 | V |
| Output Voltage (Note 3) | | V _O | V ⁻ -0.3 to V ⁺ +0.3 | V |
| Power Dissipation | C Package (Note 4) | P _T | 350 | mW |
| | G2 Package (Note 5) | | 440 | mW |
| Output Short Circuit Duration (Note 6) | | | Indefinite | sec |
| Operating Temperature Range | | T _{opt} | -20 to +80 | °C |
| Storage Temperature Range | | T _{stg} | -55 to +125 | °C |

Note 1. Reverse connection of supply voltage can cause destruction.

Note 2. The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.

Note 3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.

Note 4. Thermal derating factor is -5.0 mW / °C when ambient temperature is higher than 55 °C.

Note 5. Thermal derating factor is -4.4 mW / °C when ambient temperature is higher than 25 °C.

Note 6. Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

RECOMMENDED OPERATING CONDITIONS

| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|----------------|----------------|------|------|------|------|
| Supply Voltage | V [±] | ± 4 | | ± 16 | V |

ELECTRICAL CHARACTERISTICS (T_a = 25 °C, V[±] = ±15 V)

| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITION |
|----------------------------------|------------------|--------|---------|------|-------------------|--|
| Input Offset Voltage | V _{IO} | | ±0.5 | ±6.0 | mV | R _s ≤ 10 kΩ |
| Input Offset Current (Note 7) | I _{IO} | | ±5 | ±200 | nA | |
| Input Bias Current (Note 7) | I _B | | 60 | 500 | nA | |
| Large Signal Voltage Gain | A _v | 20,000 | 100,000 | | | R _L ≥ 2 kΩ, V _O = ±10 V |
| Power Consumption | P _d | | 90 | 170 | mW | I _O = 0 A, Both Amplifiers |
| Common Mode Rejection Ratio | CMR | 70 | 90 | | dB | R _s ≤ 10 kΩ |
| Source Variation Rejection Ratio | SVR | | 30 | 150 | μV/V | R _s ≤ 10 kΩ |
| Output Voltage Swing | V _{OM} | ±12 | ±14 | | V | R _L ≥ 10 kΩ |
| Output Voltage Swing | V _{OM} | ±10 | ±13 | | V | R _L ≥ 2 kΩ |
| Common Mode Input Voltage Range | V _{ICM} | ±12 | ±14 | | V | |
| Slew Rate | SR | | 1.0 | | V/μs | A _v = 1 |
| Input Equivalent Noise Voltage | V _n | | 6 | | μV _{p-p} | R _s = 1 kΩ, f = 1 Hz to 1 kHz (Fig.1) |
| Channel Separation | | | 105 | | dB | f = 1 kHz (Fig.2) |

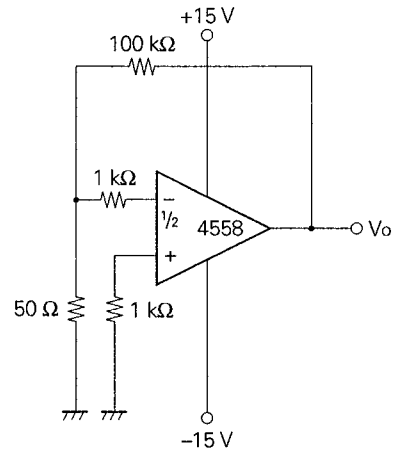
Note 7. Input bias currents flow out from IC. Because each currents are base current of PNP-transistor on input stage.

When using these ICs, pay careful attention to the following points.

1. The total of the internal power dissipation, when the loads of both channels are short-circuited at the same time.
2. The likelihood of interference between the channels, due to the temperature gradient of the chip, when the internal power dissipation of the left and right channels differ greatly in circuits handling low level inputs.

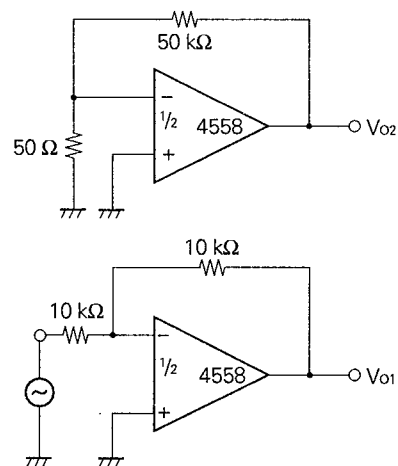
MEASUREMENT CIRCUIT

Fig. 1 Noise Measurement Circuit



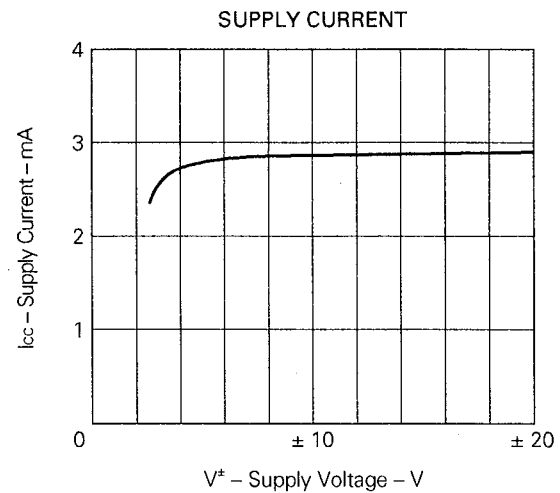
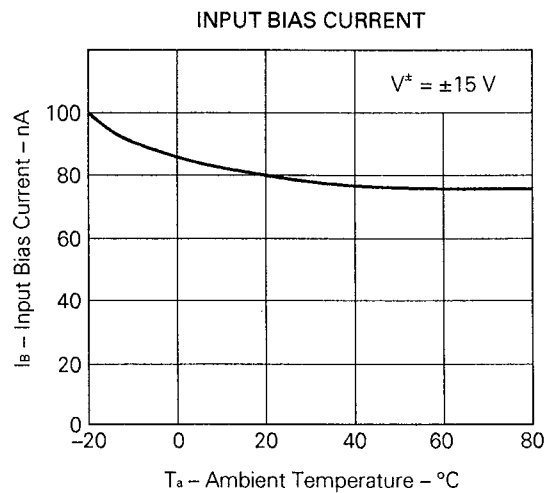
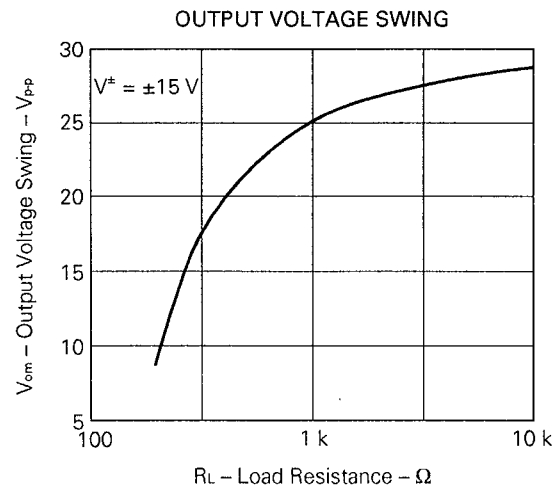
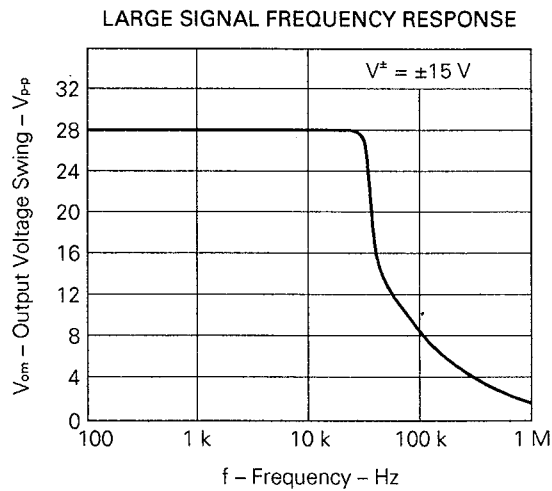
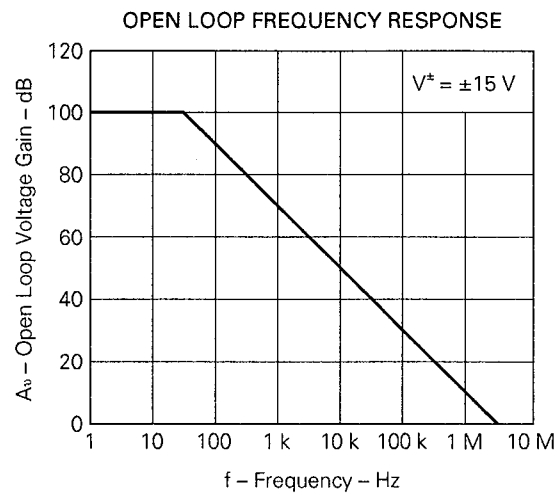
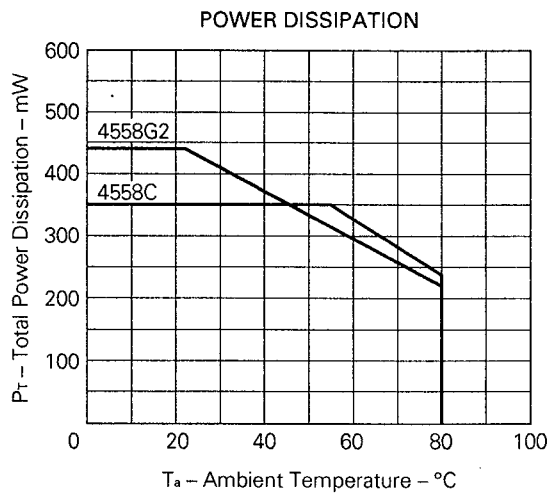
$$V_N = \frac{V_o}{2000}$$

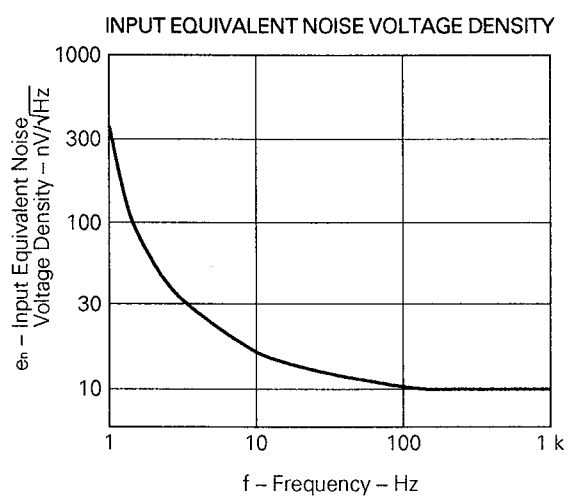
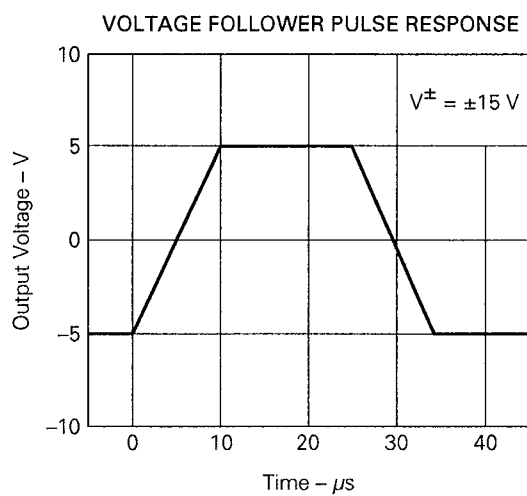
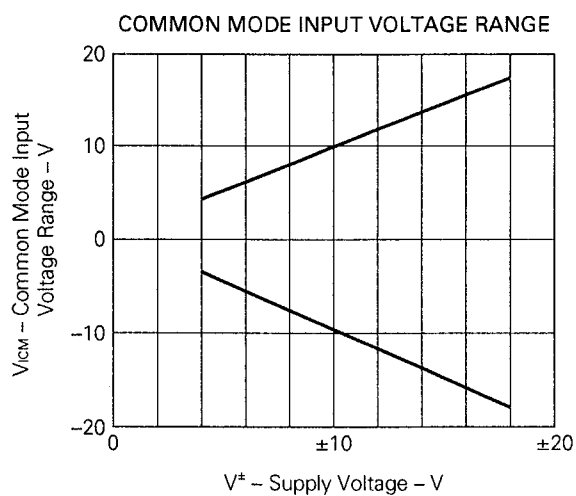
Fig. 2 Channel Separation Measurement Circuit



$$\begin{aligned} \text{Channel separation} \\ = \left| 20 \cdot \log \left(\frac{1}{1000} \cdot \frac{V_{o2}}{V_{o1}} \right) \right| \end{aligned}$$

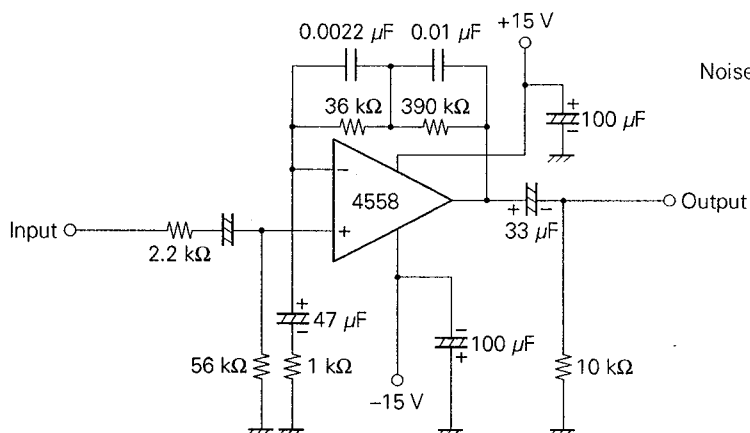
TYPICAL PERFORMANCE CHARACTERISTICS ($T_a = 25^\circ\text{C}$, TYP.)





APPLICATION CIRCUIT

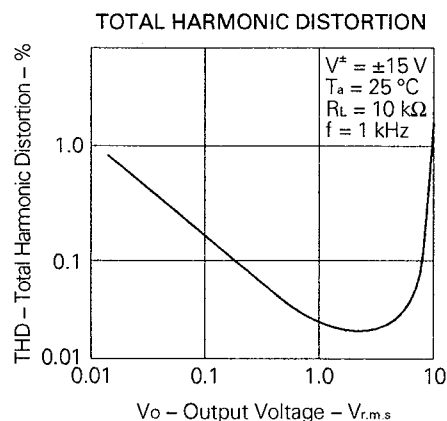
RIAA PREAMP ($A_v = 32.5$ dB)



TYPICAL CHARACTERISTIC

Distortion 0.03 % ($V_o = 1 V_{r.m.s.}$, $f = 1$ kHz)

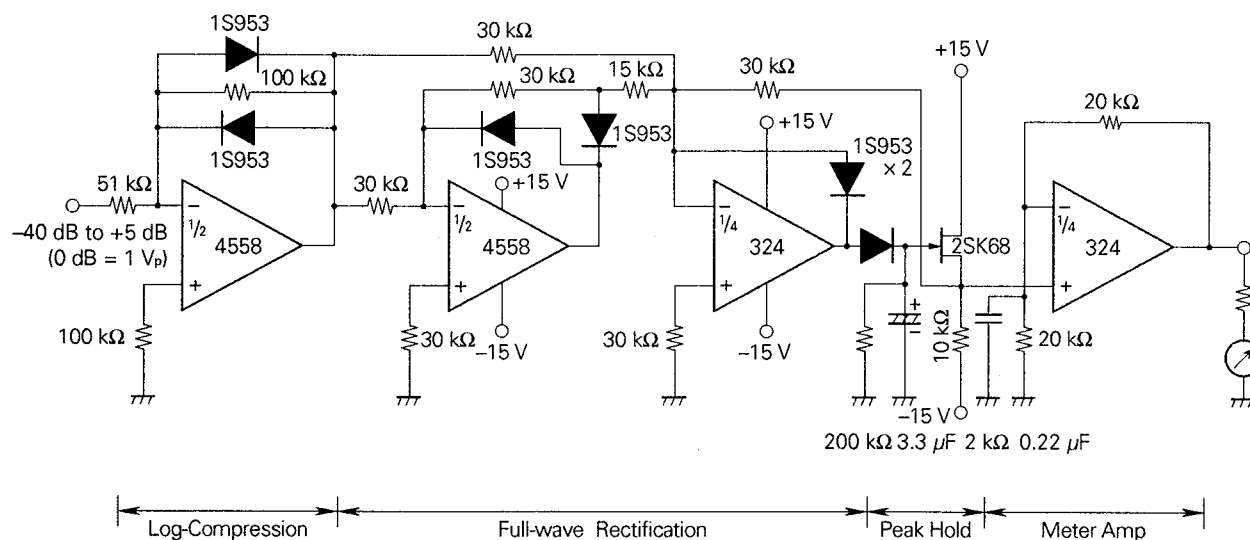
Noise $1.0 \mu V_{r.m.s.}$ (Input Equiv., Input Short
Peak Det., Average Indication)



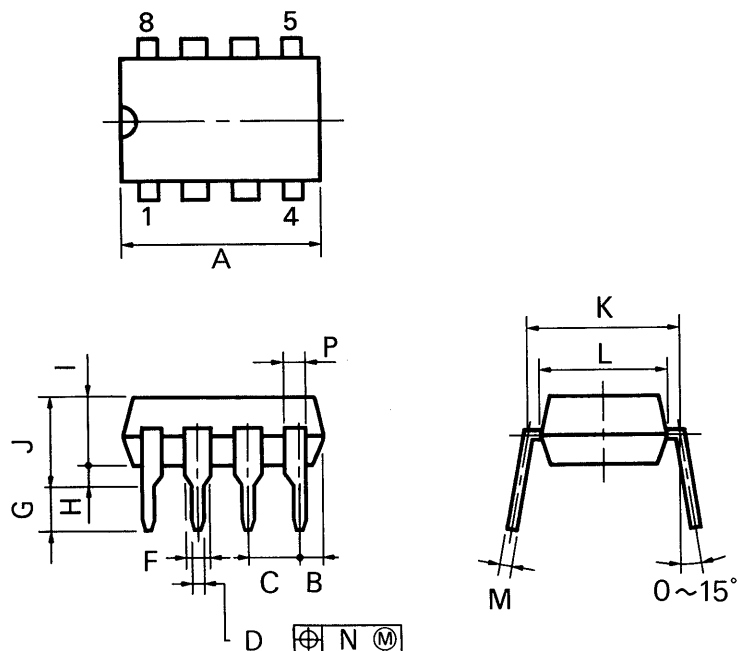
PEAK LEVEL METER

This circuit converts the peak voltage (about ± 10 mV to ± 10 V) of the input signal to a DC voltage (about 0.2 V to 1.3 V) and drives the meter.

Since the output voltage is proportional to the logarithmic value of the peak voltage of the input signal, indication of a much wider dynamic range can be obtained compared to conventional linear indicating methods.



8PIN PLASTIC DIP (300 mil)



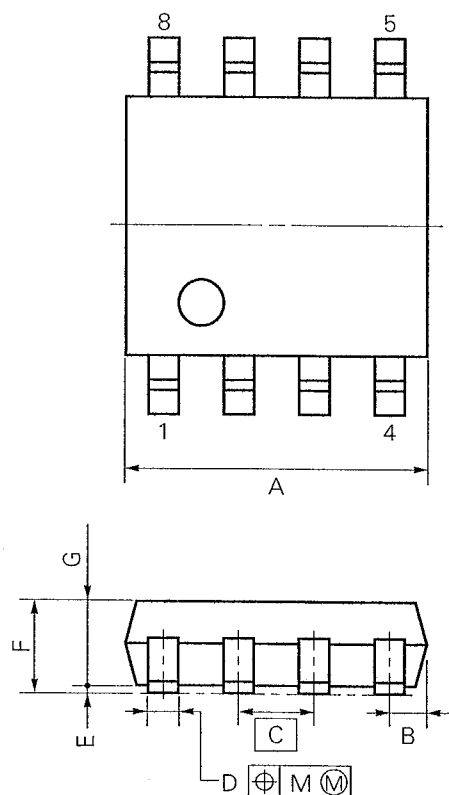
P8C-100-300B,C

NOTES

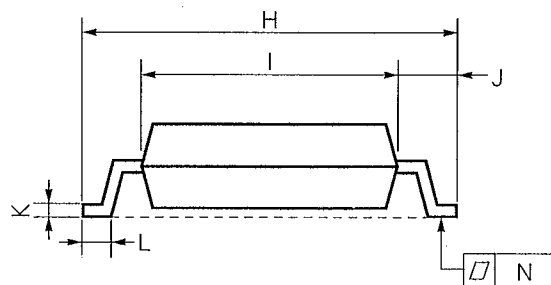
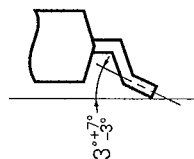
- 1) Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

| ITEM | MILLIMETERS | INCHES |
|------|------------------------|---------------------------|
| A | 10.16 MAX. | 0.400 MAX. |
| B | 1.27 MAX. | 0.050 MAX. |
| C | 2.54 (T.P.) | 0.100 (T.P.) |
| D | $0.50^{+0.10}_{-0.05}$ | $0.020^{+0.004}_{-0.005}$ |
| F | 1.4 MIN. | 0.055 MIN. |
| G | $3.2^{+0.3}_{-0.0}$ | $0.126^{+0.012}_{-0.000}$ |
| H | 0.51 MIN. | 0.020 MIN. |
| I | 4.31 MAX. | 0.170 MAX. |
| J | 5.08 MAX. | 0.200 MAX. |
| K | 7.62 (T.P.) | 0.300 (T.P.) |
| L | 6.4 | 0.252 |
| M | $0.25^{+0.10}_{-0.05}$ | $0.010^{+0.004}_{-0.003}$ |
| N | 0.25 | 0.01 |
| P | 0.9 MIN. | 0.035 MIN. |

8 PIN PLASTIC SOP (225 mil)



detail of lead end



NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

S8GM-50-225B-2

| ITEM | MILLIMETERS | INCHES |
|------|--|---|
| A | 5.37 MAX. | 0.212 MAX. |
| B | 0.78 MAX. | 0.031 MAX. |
| C | 1.27 (T.P.) | 0.050 (T.P.) |
| D | 0.40 ^{+0.10} _{-0.05} | 0.016 ^{+0.004} _{-0.003} |
| E | 0.1±0.1 | 0.004±0.004 |
| F | 1.8 MAX. | 0.071MAX. |
| G | 1.49 | 0.059 |
| H | 6.5±0.3 | 0.256±0.012 |
| I | 4.4 | 0.173 |
| J | 1.1 | 0.043 |
| K | 0.15 ^{+0.10} _{-0.05} | 0.006 ^{+0.004} _{-0.002} |
| L | 0.6±0.2 | 0.024 ^{+0.008} _{-0.009} |
| M | 0.12 | 0.005 |
| N | 0.15 | 0.006 |

RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be met when soldering this product.

Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

TYPES OF SURFACE MOUNT DEVICE

For more details, refer to our document "SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL" (IEI-1207).

[μ PC4558G2]

| Soldering method | Soldering conditions | Recommended condition symbol |
|------------------------|--|------------------------------|
| Infrared ray reflow | Peak package's surface temperature: 230 °C or below, Reflow time: 30 seconds or below (210 °C or higher), Number of reflow process: 1, Exposure limit*: None | IR30-00-1 |
| VPS | Peak package's surface temperature: 215 °C or below, Reflow time: 40 seconds or below (200 °C or higher), Number of reflow process: 1, Exposure limit*: None | VP15-00-1 |
| Wave soldering | Solder temperature: 260 °C or below, Flow time: 10 seconds or below Number of flow process: 1, Exposure limit*: None | WS15-00-1 |
| Partial heating method | Terminal temperature: 300 °C or below, Flow time: 10 seconds or below, Exposure limit*: None | |

*: Exposure limit before soldering after dry-pack package is opened.
Storage conditions: 25 °C and relative humidity at 65 % or less.

Note: Do not apply more than a single process at once, except for "Partial heating method".

TYPES OF THROUGH HOLE DEVICE

[μ PC4558C]

| Soldering method | Soldering conditions | Recommended condition symbol |
|------------------|--|------------------------------|
| Wave soldering | Solder temperature: 260 °C or below, Flow time: 10 seconds or below | |

[MEMO]

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Application examples recommended by NEC Corporation.

Standard: Computer, Office equipment, Communication equipment, Test and Measurement equipment, Machine tools, Industrial robots, Audio and Visual equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Traffic control systems, Antidisaster systems, Anticrime systems, etc.